



SPECIFICATION

• Supplier : Samsung electro-mechanics • Samsung P/N : CL31A107MQHNNNE

• Product : Multi-layer Ceramic Capacitor • Description : CAP, 100 µF, 6.3V, ±20%, X5R, 1206

A. Samsung Part Number

<u>CL</u> <u>31</u> <u>A</u> <u>107</u> <u>M</u> <u>Q</u> <u>H</u> <u>N</u> <u>N</u> <u>N</u> <u>E</u> ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪

1	Series	Samsung Multi-layer Ceramic Capacitor			
2	Size	1206 (inch code)	L: 3.2 ± 0.2 mm	W: 1.6 ± 0.2	mm
3	Dielectric	X5R	8 Inner electrode	Ni	
4	Capacitance	100 μF	Termination	Cu	
⑤	Capacitance	±20 %	Plating	Sn 100%	(Pb Free)
	tolerance		Product	Normal	
6	Rated Voltage	6.3 V	Special	Reserved for future use	
7	Thickness	1.6 ± 0.2 mm	Packaging	Embossed Type, 7" reel(2,000ea)	

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition			
Capacitance	Within specified tolerance	120Hz ±20% 0.5±0.1Vrms			
Tan δ (DF)	0.1 max.				
Insulation	More than 50Mohm⋅μF	Rated Voltage 60~120 sec.			
Resistance					
Appearance No abnormal exterior appearan		Visual inspection			
Withstanding	No dielectric breakdown or	250% of the rated voltage			
Voltage mechanical breakdown					
Temperature X5R					
Characteristics	(From -55℃ to 85℃, Capacitance change should be within ±15%)				
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.			
of Termination	terminal electrode				
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)			
		with 1.0mm/sec.			
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder			
	is to be soldered newly	245±5°C, 3±0.3sec.			
		(preheating : 80~120 ℃ for 10~30sec.)			
Resistance to	Capacitance change: within ±7.5%	Solder pot : 270±5℃, 10±1sec.			
Soldering heat	Tan δ, IR : initial spec.				

	Performance	Test condition
Vibration Test	Capacitance change: within ±5%	Amplitude : 1.5mm
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)
		2hours × 3 direction (x, y, z)
Moisture	Capacitance change: within ±12.5%	With rated voltage
Resistance	Tan δ : 0.25 max	40±2℃, 90~95%RH, 500+12/-0 hour
	IR : More than 3.5MΩ·μF	
High Temperature	Capacitance change: within ±12.5%	With 100% of the rated voltage
Resistance	Tan δ : 0.25 max	Max. operating temperature
	IR : More than 7MΩ·μF	
		1000+48/-0 hour
Temperature	Capacitance change: within ±15%	1 cycle condition
Cycling	Tan δ, IR : initial spec.	Min. operating temperature → 25°C
		→ Max. operating temperature → 25°C
		5 cycles test

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5 $^{\circ}$ C , 10sec. Max)

^{*} For the more detail Specification, Please refer to the Samsung MLCC catalogue.